

Features

- Dual bidirectional Translator for SDA and SCL Lines in I3C Applications and SMBus Compatible
- Support multi-mode: Standard-mode (SM), Fast-mode (FM), and Fast-mode Plus (FM+)
- I3C compatible (12.5 MHz supported)
- Less than 1.5 ns (max) Delay to Accommodate SM and FM I3C devices and multiple masters
- Allows Voltage-Level Translation Between
 - 3.3V V_{REF1} and 5V V_{REF2}
 - 2.5V V_{REF1} and 3.3V or 5 V V_{REF2}
 - 1.8V V_{REF1} and 2.5V, 3.3V, or 5V V_{REF2}
 - 1.2V V_{REF1} and 1.8V, 2.5V, 3.3V, or 5V V_{REF2}
- Provides bidirectional voltage translation with no direction pin
- High-impedance SCL1, SDA1, SCL2 and SDA2 pins for EN = LOW
- Latch-Up performance exceeds 400 mA per JESD 78
- ESD Protection Exceeds JESD 22
 - 4000-V Human-Body Model
 - 1000-V Charged-Device Model

Applications

- I2C, I3C, SMBus, PMBus, MDIO, UART, Low-Speed SDIO, GPIO, and Other Two-Signal Interfaces
- Servers/Storages
- Routers (Telecom Switching Equipment)
- Personal Computers/Consumer handsets
- Industrial Automation

Description

The TPT29336 device is a dual bidirectional I3C, SMBus, and I3C voltage-level translator with an enable (EN) input, and work from 1.2V to 3.6V V_{REF1} and 1.8V to 5.5V V_{REF2} .

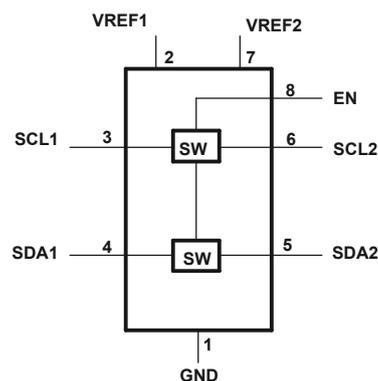
The 3.5Ω R_{on} make the minimal propagation delay <1.5ns. If EN is high, the translator switch is ON, and the SCL1 and SDA1 I/O are connected to the SCL2 and SDA2 I/O, will allow bidirectional data flow between ports. If EN is low, the translator switch is off, and a high-impedance state exists between ports to isolate both sides.

The TPT29336 can also be used to run two buses, one is 400 kHz and the other is 100 kHz. If the two buses are operating at different frequency, the 100 kHz bus must be isolated when the other 400 kHz bus is required. If the master is running at 400 kHz, the maximum system frequency may be less than 400 kHz because of the delays added by the translator.

As with the standard I3C-bus and I3C compatible system, pull-up resistors are required in both sides, to provide the logic HIGH levels on the translator's bus. The device is designed to work with SM, FM and FM+ I3C-bus devices in addition to SMBus devices. The maximum frequency is dependent on the RC time constant, and supports 12.5 MHz.

TPT29336 is available in MSOP8 and VSSOP8 package, and is characterized from -40°C to +125°C.

Function block

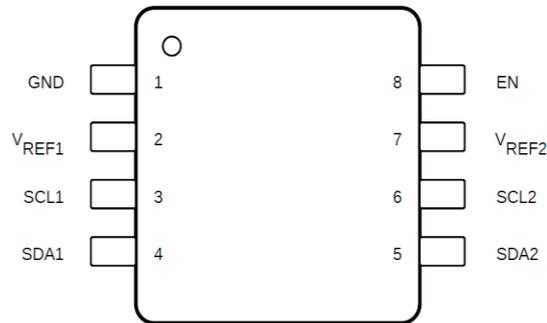


Revision History

Date	Revision	Notes
2022/7/12	Rev. Pre 0	Initial Version
2022/12/14	Rev. A.0	Released version

Pin Configuration and Functions

TPT29336-VS1R
 (MSOP8, 3.0 x 3.0 x 0.9 mm)
 TPT29336-VS3R-S
 (VSSOP8, 2.0 x 2.3 x 1.0 mm)



Pin Functions

Pin name	Pin No	I/O	Description
GND	1	—	Ground, 0 V
VREF1	2	I	Low-voltage-side reference supply voltage for SCL1 and SDA1
SCL1	3	I/O	Serial clock, low-voltage side
SDA1	4	I/O	Serial data, low-voltage side
SDA2	5	I/O	Serial data, high-voltage side
SCL2	6	I/O	Serial clock, high-voltage side
VREF2	7	I	High-voltage-side reference supply voltage for SCL2 and SDA2, connect to power supply through external 200kΩ pull up resistor
EN	8	I	Switch enable input, directly connect to VREF2

Absolute Maximum Ratings ⁽¹⁾

Parameter		MIN	MAX	UNIT
V _{REF1}	DC reference voltage range	-0.5	7	V
V _{REF2}	DC reference bias voltage range	-0.5	7	V
V _I	Input voltage range ⁽²⁾	-0.5	7	V
V _{I/O}	Input/output voltage range ⁽²⁾	-0.5	7	V
	Continuous channel current		128	mA
I _{IK}	Input clamp current V _I < 0		-50	mA
T _{J(max)}	Maximum junction temperature		125	°C
T _{stg}	Storage temperature range	-65	150	°C

* Note: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

(1) This data was taken with the JEDEC low effective thermal conductivity test board.

(2) This data was taken with the JEDEC standard multilayer test boards.

ESD, Electrostatic Discharge Protection

Symbol	Parameter	Condition	Minimum Level	Unit
HBM	Human Body Model ESD	ANSI/ESDA/JEDEC JS-001	4	kV
CDM	Charged Device Model ESD	ANSI/ESDA/JEDEC JS-002	1	kV

Thermal Information

Package Type	θ_{JA}	θ_{JC}	Unit
MSOP8	205	45	°C/W
VSSOP8	210	82	°C/W

Recommended Operating Conditions

Symbol	Description	MIN	MAX	UNIT
V _{I/O}	Input/output voltage SCL1, SDA1, SCL2, SDA2	0	5.5	V
V _{REF1} ⁽¹⁾	Reference voltage	0	5.5	V
V _{REF2} ⁽¹⁾	Reference voltage	0	5.5	V
EN	Enable input voltage	0	5.5	V
I _{PASS}	Pass switch current		64	mA
T _A	Operating ambient temperature	-40	125	°C

(1) To support translation, V_{REF1} suggest to be 0.6V lower than V_{REF2}. Please see the Application information as reference.

Electrical Characteristics

All test condition is VDD = 3.3V, TA = +25°C, RL = 150Ω to GND

Symbol	Description	Test Conditions		Min	Typ	Max	Unit			
V _{IK}	Input clamp voltage ^{note1}	I _I = -18 mA,	EN = 0 V			-1.2	V			
I _{IH}	Input leakage current	V _I = 5 V,	EN = 0 V			5	μA			
C _{i(EN)}	Input capacitance	V _I = 3 V or 0			11		pF			
C _{io(off)}	Off capacitance, SCLn, SDAn	V _O = 3 V or 0,	EN = 0 V		4	6	pF			
C _{io(on)}	On capacitance, SCLn, SDAn	V _O = 3 V or 0,	EN = 3 V		10.5	12.5	pF			
R _{ON}	On-state resistance, SCLn, SDAn	V _I = 0	I _O = 64 mA	EN = 4.5 V	3.5	5.5	Ω			
				EN = 3 V	4.7	7				
				EN = 2.3 V	6.3	9.5				
		V _I = 0	I _O = 15 mA	EN = 1.5 V	25.5	32				
				V _I = 2.4 V ⁽³⁾	I _O = 15 mA	EN = 4.5 V		1	6	15
						EN = 3 V		20	60	140
V _I = 1.7 V ⁽³⁾	I _O = 15 mA	EN = 2.3 V	20	60	140					

Note1: symbol '-' means direction, sink current 18mA, input voltage 1.2V, typical value: input voltage 0.8V

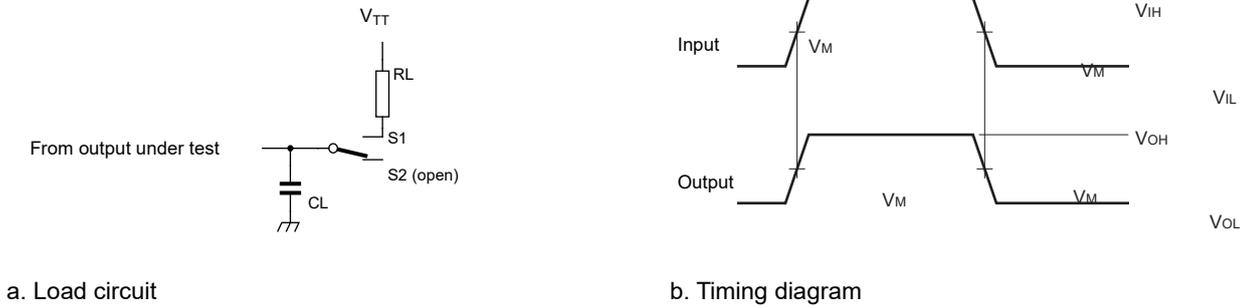
Switching Characteristics AC Performance, TA = +25°C (Translating Down) (Fig. 1)

AC Electrical Specifications, Translating Down, EN = 3.3 V, V _{IH} = 3.3 V; V _{IL} = 0 V; V _M = 1.15 V									
Parameter	From (Input)	To (Output)	C _L = 50 pF		C _L = 30 pF		C _L = 15 pF		Unit
			Min	Max	Min	Max	Min	Max	
t _{PLH}	SCL2 or SDA2	SCL1 or SDA1	0	0.8	0	0.6	0	0.3	ns
t _{PHL}			0	1.2	0	1	0	0.5	
AC Electrical Specifications, Translating Down, EN = 2.5 V, V _{IH} = 2.5 V; V _{IL} = 0 V; V _M = 0.75 V									
Parameter	From (Input)	To (Output)	C _L = 50 pF		C _L = 30 pF		C _L = 15 pF		Unit
			Min	Max	Min	Max	Min	Max	
t _{PLH}	SCL2 or SDA2	SCL1 or SDA1	0	0.8	0	0.6	0	0.3	ns
t _{PHL}			0	1.2	0	1	0	0.5	

Switching Characteristics AC Performance, TA = +25°C (Translating Up) (Fig. 6)

AC Electrical Specifications, Translating Up, EN = 3.3 V, V _{IH} = 2.3 V; V _{IL} = 0 V; V _{TT} = 3.3 V; V _M = 1.15 V; R _L = 300									
Parameter	From (Input)	To (Output)	C _L = 50 pF		C _L = 30 pF		C _L = 15 pF		UNIT
			Min	Max	Min	Max	Min	Max	
t _{PLH}	SCL2 or SDA2	SCL1 or SDA1	0	0.9	0	0.6	0	0.4	ns
t _{PHL}			0	1.4	0	1.1	0	0.7	
AC Electrical Specifications, Translating Up, EN = 2.5 V, V _{IH} = 1.5 V; V _{IL} = 0 V; V _{TT} = 2.5 V; V _M = 0.75 V; R _L = 300									
Parameter	From (Input)	To (Output)	C _L = 50 pF		C _L = 30 pF		C _L = 15 pF		UNIT
			Min	Max	Min	Max	Min	Max	
t _{PLH}	SCL2 or SDA2	SCL1 or SDA1	0	0.9	0	0.6	0	0.4	ns
t _{PHL}			0	1.4	0	1.1	0	0.7	

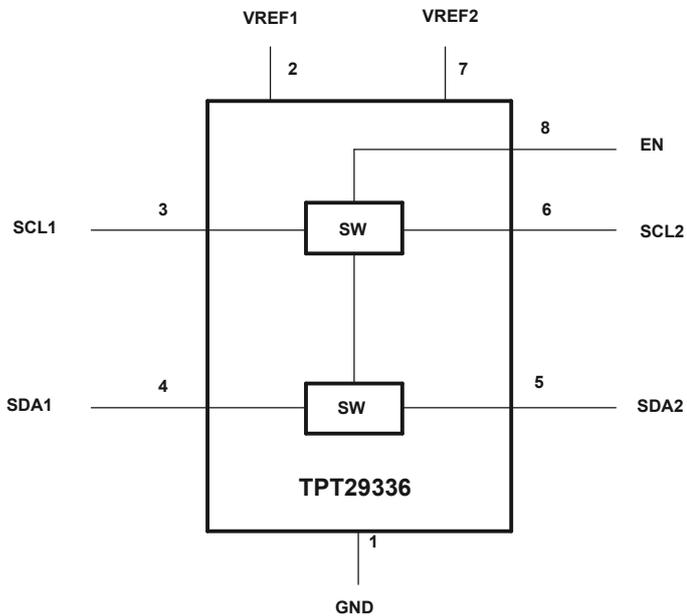
Typical Performance Characteristics-TPT29336



S1 = translating up; S2 = translating down.
 CL includes probe and jig capacitance.
 The outputs are measured one at a time, with one transition per measurement.

Figure 1. Load circuit for outputs

Function Block Diagram



Theory of Operation

The TPT29336 device is a dual bidirectional I3C and SMBus voltage-level translator with an enable (EN) input and operates without use of a direction pin, and I3C compatible (12.5 MHz supported). The voltage supply range for V_{REF1} is 1.0 V to 3.6 V and the supply range for V_{REF2} is 1.65 V to 5.5 V.

The TPT29336 device can also be used to run two buses, one at 400 kHz frequency and the other at 100 kHz frequency. If the two buses are operating at different frequencies, the 100 kHz bus must be isolated by using the EN pin when the 400 kHz operation of the main bus is required. If the master is running at 400 kHz, the maximum system operating frequency may be less than 400 kHz because of the delays added by the level translator.

In I3C applications, the bus capacitance limit of 400 pF decides the number of devices and bus length. The capacitive load on both sides of the TPT29336 device must be calculated together, including the total load of the system, then make sure the sum of both sides is under 400 pF.

Both the SDA and SCL channels of the TPT29336 device have the same electrical characteristics, and there is minimal deviation from one output to another in voltage or propagation delay. Compared to the discrete transistor voltage-translation solutions, TPT29336 is a good benefit because of the symmetric design and accurate manufacture. The level shifter provides excellent ESD protection to lower-voltage devices and also protects low-level ESD devices.

Enable (EN) Pin

The TPT29336 device is an open-drain circuit in which the gate of the transistors is controlled by the voltage on the EN pin. In Figure 2 the TPT29336 device is always enabled when power is applied to V_{REF2} . In Figure 3, the device is enabled when a control signal from a processor is in a logic-high state.

Voltage Translation

The primary feature of the TPT29336 device is translating voltage from an I3C bus V_{REF1} to I3C bus V_{REF2} . Side-1 is referenced to V_{REF1} up to an I3C bus referenced to $V_{DPU}(VCC1)$, and side-2 V_{REF2} is connected through a 200 k Ω pullup resistor. Translation on a standard, open-drain I3C bus is achieved by simply connecting pullup resistors from SCL1 and SDA1 to V_{REF1} , and connecting pullup resistors from SCL2 and SDA2 to $VCC2$.

Device Function table

Input EN ⁽¹⁾	Translator Function
H	SCL1 = SCL2, SDA1 = SDA2
L	Disconnect

(1) The SCL switch conducts if EN is ≥ 1 V higher than SCL1 or SCL2. The same is true of SDA.

Application information

General Applications of I3C

As with the standard I3C system, pullup resistors are required to provide the logic-high levels on the translator bus. The size of these pullup resistors depends on the system, but each side of the repeater must have a pullup resistor. The device is designed to work with standard-mode and fast-mode I3C devices, in addition to SMBus devices. Standard-mode I3C devices only specify 3 mA in a generic I3C system where standard-mode devices and multiple masters are possible. Under certain conditions, high termination currents can be used. When the SDA1 or SDA2 port is low, the clamp is in the ON state, and a low-resistance connection exists between the SDA1 and SDA2 ports. Assuming the higher voltage is on the SDA2 port when the SDA2 port is high, the voltage on the SDA1 port is limited to the voltage set by V_{REF1} . When the SDA1 port is high, the SDA2 port is pulled to the pullup supply voltage of the drain by the pullup resistors. This functionality allows a seamless translation between higher and lower voltages selected by the user, without the need for directional control. The SCL1-SCL2 channel also functions in the same way as the SDA1-SDA2 channel.

Typical Application

Figure 2 and Figure 3 show how these pullup resistors are connected in a typical application, as well as two options for connecting the EN pin.

Power Supply Requirements

For supplying power to the TPT29336 device, the V_{REF1} pin can be connected directly to a power supply. The V_{REF2} pin **MUST** be connected to the VCC2 power supply through a 200 k Ω resistor. Failure to have a high impedance resistor between V_{REF2} and V_{DPU} results in excessive current draw and unreliable device operation. It is also worth noting, that in order to support voltage translation, the TPT29336 **MUST** have the EN and V_{REF2} pins shorted and then pulled up to VCC2 through a high-impedance resistor (200 k Ω).

Bidirectional Voltage Translation

For the bidirectional clamping configuration, could be higher voltage to lower voltage or lower voltage to higher voltage, the EN input must be connected to V_{REF2} and both pins pulled to high-side power supplier through a pullup resistor (typically 200 k Ω as recommend above). This allows V_{REF2} to regulate the EN input and a 100 pF filter capacitor connected to V_{REF2} is recommended. The I3C bus master output can be push-pull, if it is open-drain output then it should connect to pullup resistors. However, if either output is push-pull, data(SDA) must be unidirectional or the outputs must be 3-state capable and be controlled by some direction-control circuit to prevent high-to-low competition in either direction. If both outputs are open-drain, no direction control is needed.

The reference supply voltage (V_{REF1}) is connected to the core power-supply voltage of the I3C master, and V_{REF2} is connect to the I3C slave through 200 k Ω pullup resistor.

Design Requirements

		Min	Typ ⁽¹⁾	Max	UNIT
V_{REF2}	Reference voltage	$V_{REF1} + 0.6$	2.1	5	V
EN	Enable input voltage	$V_{REF1} + 0.6$	2.1	5	V
V_{REF1}	Reference voltage	1.2	1.5	4.4	V

Dual Bidirectional I3C Bus and SMBus Voltage-Level Translator

IPASS	Pass switch current	6	mA
IREF	Reference-transistor current	5	μA

(1) All typical values are at T_A = 25°C.

Typical Application Circuit

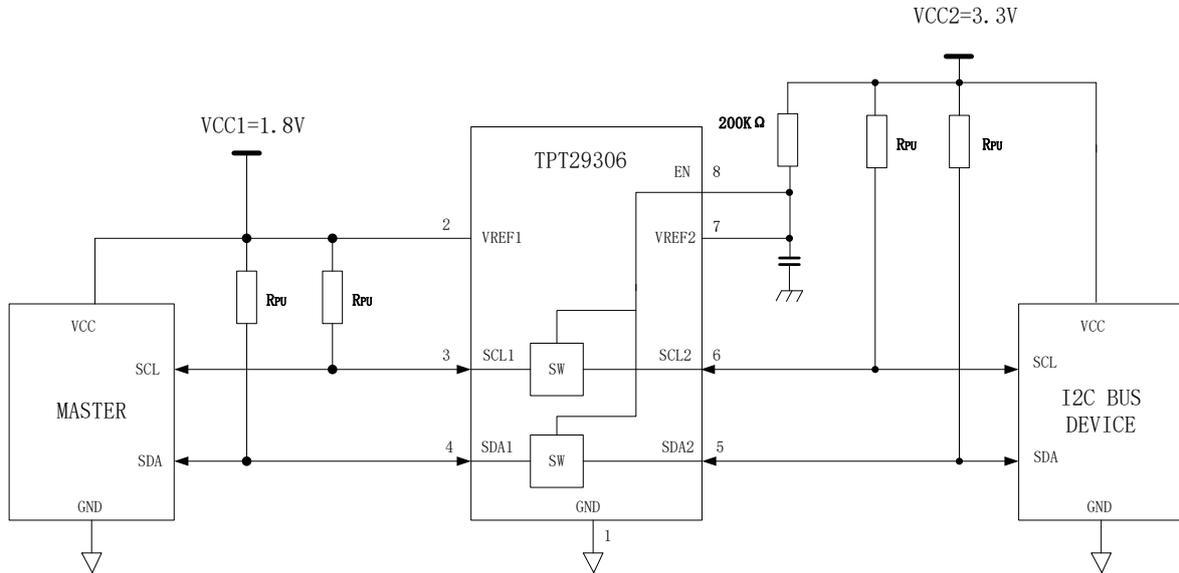


Figure 2. Typical application circuit, switch always Enable

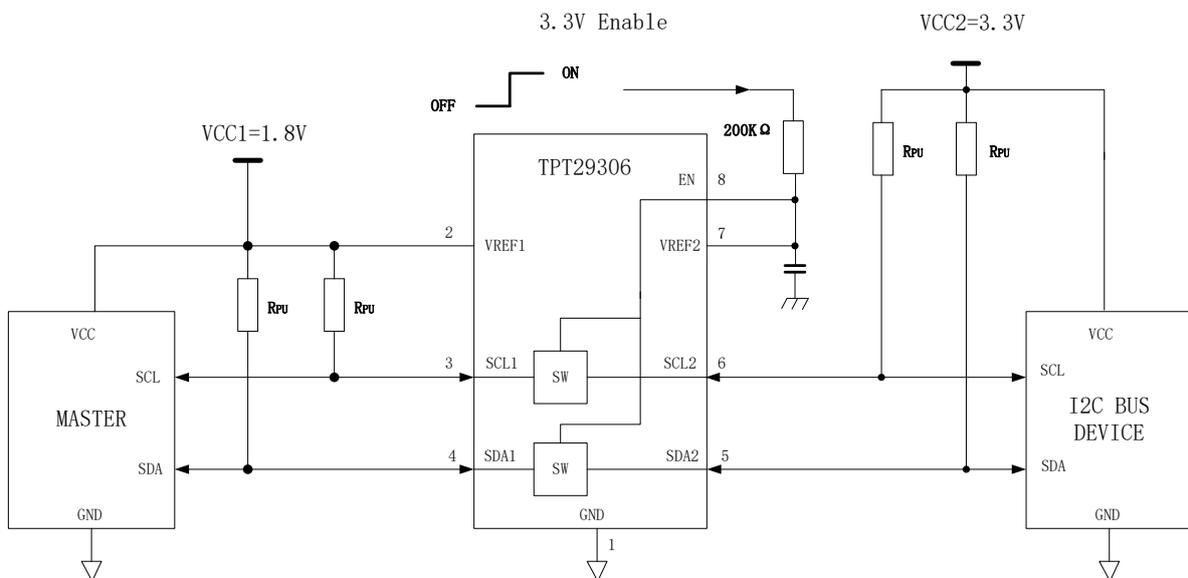


Figure 3. Typical application circuit, switch Enable control by I/O input

Pullup Resistors

To get an estimate for the range of values that can be used for the pullup resistor, please refer to Figure 4 and Figure 5, which shows the maximum and minimum pullup resistance allowable by the I3C specification for standard-mode (100 kHz) and fast-mode (400 kHz) operation.

No pullup resistor is needed on the host side (3.3 V) if the TPT29336 device is being driven by standard CMOS push-pull output driver.

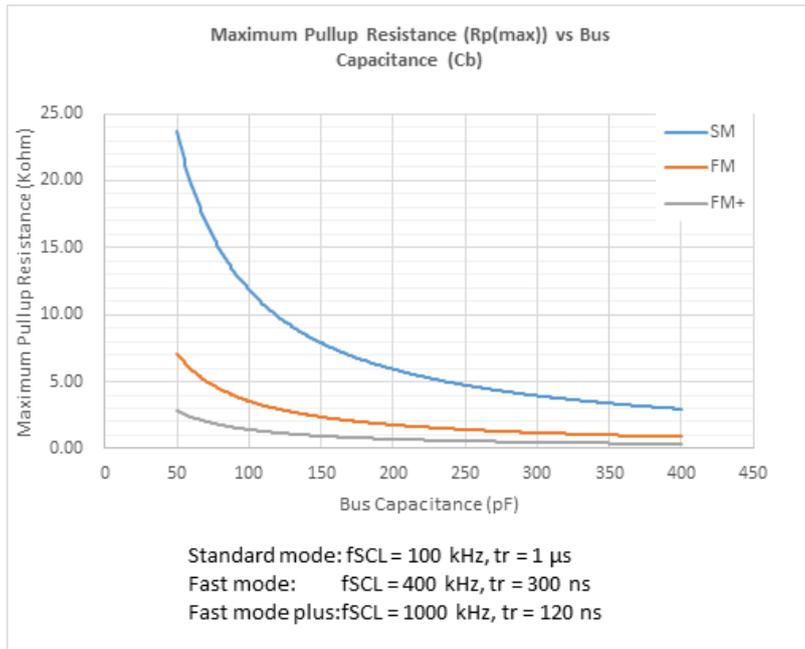


Figure 4. Maximum Pullup Resistance ($R_{pu(max)}$) vs Bus Capacitance (C_b)

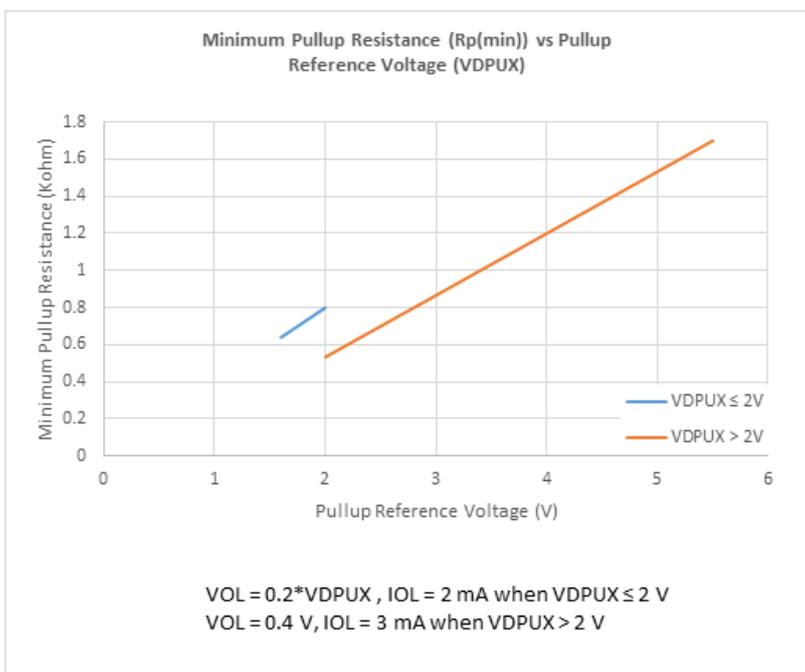


Figure 5. Minimum Pullup Resistance ($R_{pu(min)}$ as V_{CC1}) vs Pullup Reference Voltage (V_{DPUX} as V_{CC2})

Bandwidth

The maximum frequency of the TPT29336 device depends on the application. The device can operate at speeds of > 100 MHz given the correct conditions. The maximum frequency is dependent upon the loading of the application. The TPT29336 device acts as a standard switch, and the bandwidth of the device is decided by the on-resistance and on-capacitance of the device.

Figure 6 shows a bandwidth measurement of the TPT29336 device using a two-port network analyzer.

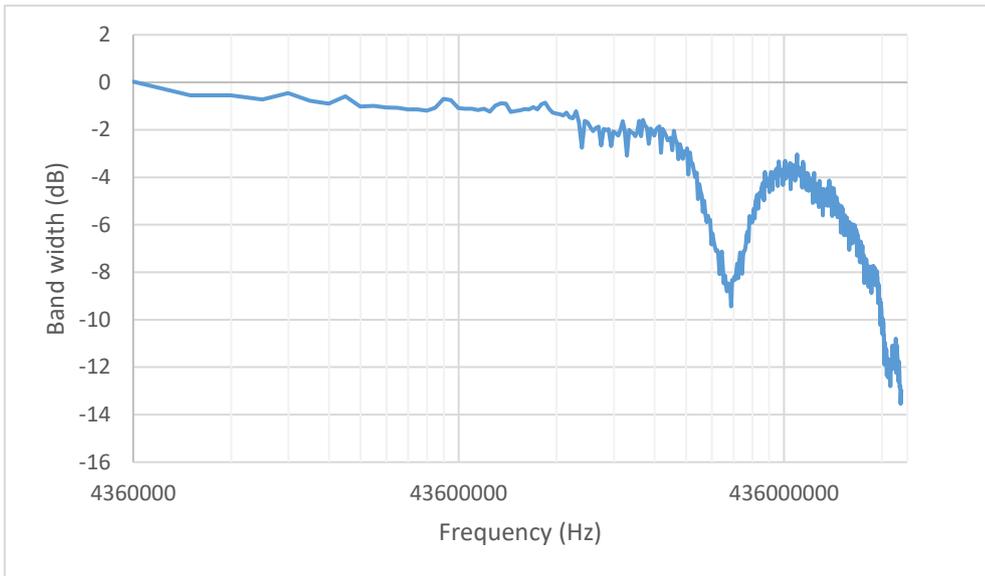


Figure 6. Typical bandwidth reference

You can then use a simple formula to calculate the maximum frequency component (F0).

$$F0 = 0.5 / RT \text{ (10\%–90\%)}$$

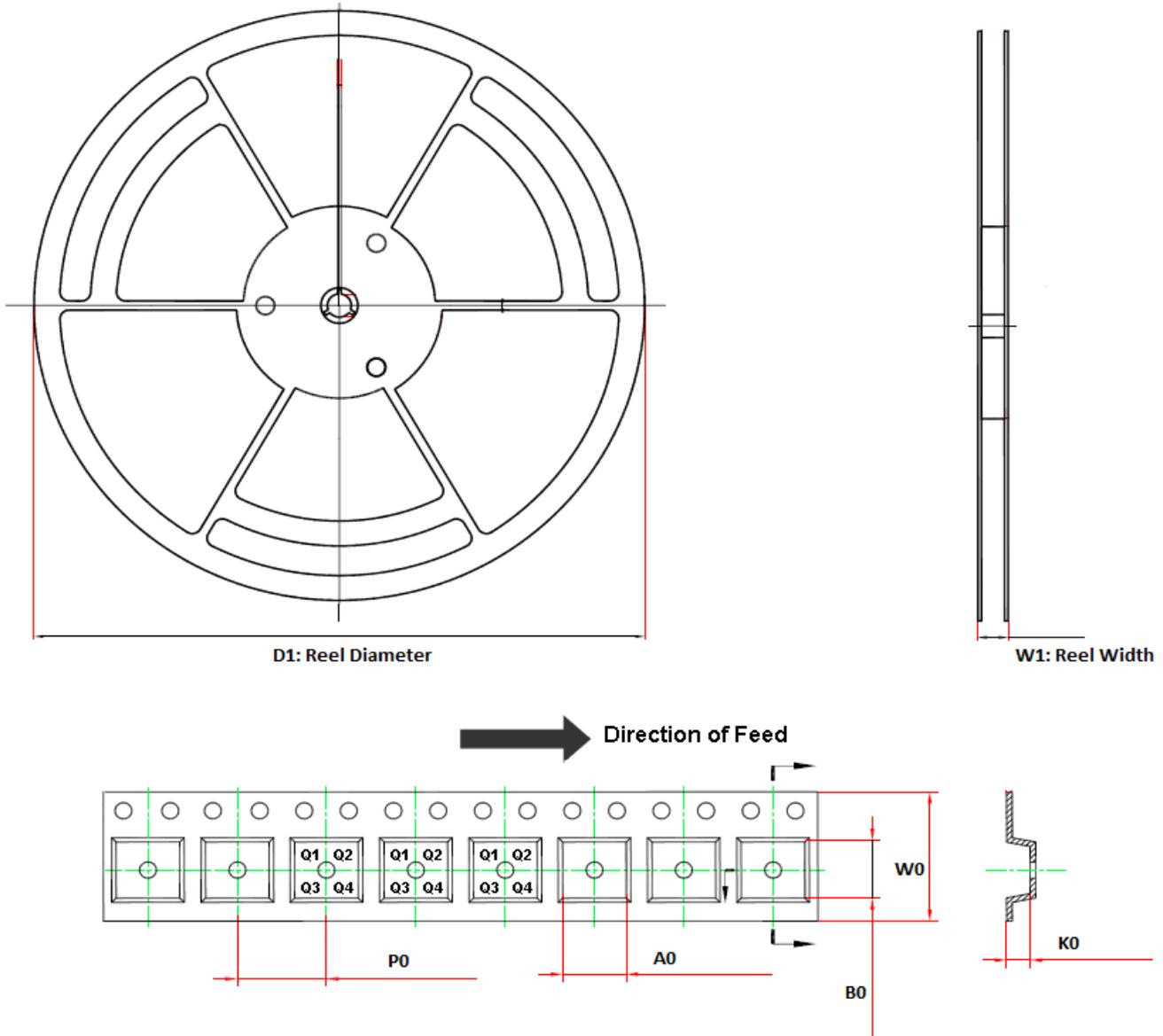
$$F0 = 0.4 / RT \text{ (20\%–80\%)}$$

For signals with rise-time characteristics based on 10% to 90% thresholds, F0 is equal to 0.5 divided by the rise time of the signal. For signals with rise-time characteristics based on 20% to 80% thresholds, which is very common in many current device specifications, F0 is equal to 0.4 divided by the rise time of the signal. The digital clock frequency of >100 MHz can be achieved.

Some guidelines to follow that help maximize the performance of the device:

- Keep trace length to a minimum by placing the TPT29336 device close to the I3C output of the master.
- The trace length should be less than half the time of flight to reduce ringing and line reflections or nonmonotonic behavior in the switching region.
- To reduce overshoots, a pullup resistor can be added on the VREF1 side, then it will result a slower fall time.

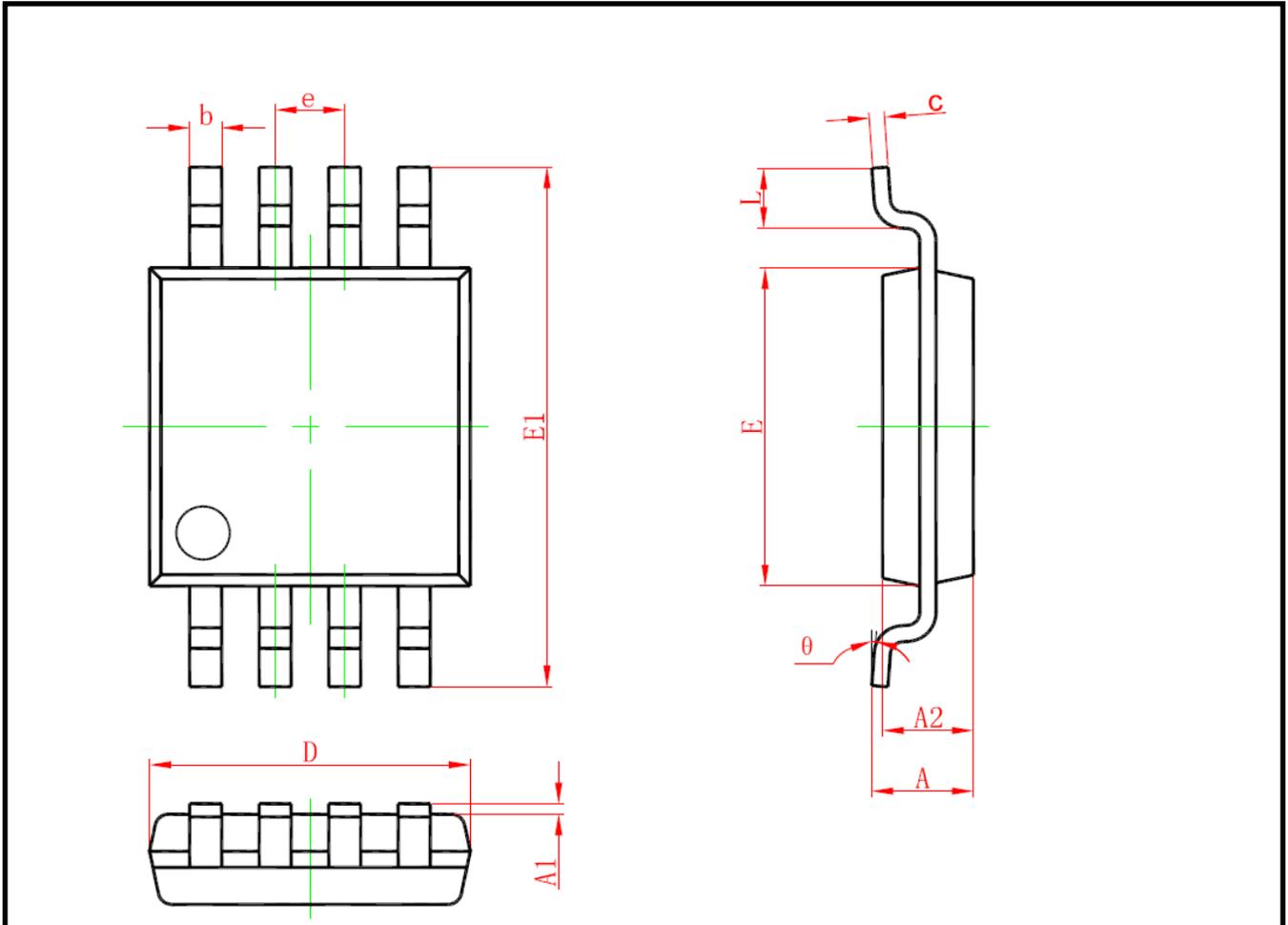
Tape and Reel Information



Order Number	Package	D1	W1	A0	B0	K0	P0	W0	Pin1 Quadrant
TPT29336-VS1R	8-Pin MSOP	330.0	17.6	5.2	3.3	1.5	8.0	12.0	Q1
TPT29336-VS3R	8-Pin VSSOP	178.0	15	2.25	3.35	1.4	4.0	8.0	Q3

Package Outline Dimensions

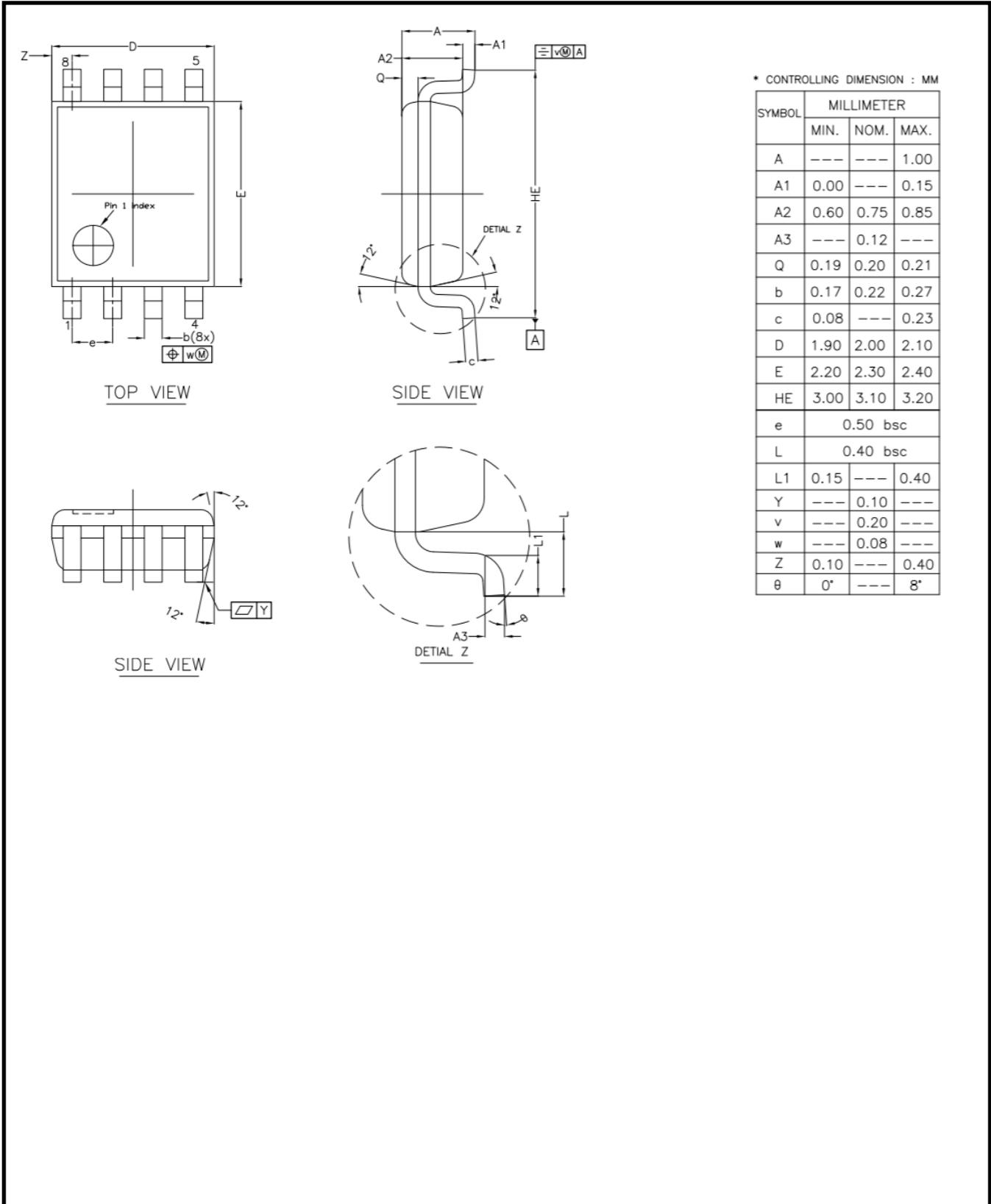
VS1R (MSOP8)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.820	1.100	0.032	0.043
A1	0.020	0.150	0.001	0.006
A2	0.750	0.950	0.030	0.037
b	0.250	0.380	0.010	0.015
c	0.090	0.230	0.004	0.009
D	2.900	3.100	0.114	0.122
e	0.650(BSC)		0.026(BSC)	
E	2.900	3.100	0.114	0.122
E1	4.750	5.050	0.187	0.199
L	0.400	0.800	0.016	0.031
θ	0°	6°	0°	6°

Package Outline Dimensions

VS3R (VSSOP8)



Order Information

Order Number	Operating Temperature Range	Package	Marking Information	MSL	Transport Media, Quantity	Eco Plan
TPT29336-VS1R ⁽¹⁾	-40 to 125°C	8-Pin MSOP	9306	MSL3	Tape and Reel, 3000	Green
TPT29336-VS3R ⁽¹⁾	-40 to 125°C	8-Pin VSSOP8	36	MSL1	Tape and Reel, 3000	Green

(1). Future product, contact 3PEAK factory for more information and sample

(2). Green: 3PEAK defines "Green" to mean RoHS compatible and free of halogen substances.

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